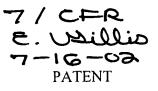


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6-4-02

Date

Michelle McVay

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants

Reishi Naka et al.

Application No.

10/004,538

Filed

October 23, 2001

For

HEAT CONDUCTIVITY MEASUREMENT METHOD AND

INSTRUMENT AND METHOD OF PRODUCING A HEAT

INSULATING MATERIAL

Art Unit

2859

Docket No.

980039.409

Date

June 4, 2002

Commissioner for Patents
Office of Initial Patent Examination
Customer Service Center
Washington, DC 20231

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents:

Attached is a copy of the official Filing Receipt received from the PTO in the above-identified application, for which issuance of a corrected Filing Receipt is respectfully requested.

There is an error with respect to the following data, which is incorrectly entered. There is an error in the Foreign Applications Number, which should read JAPAN 2000-327333 10/26/2000.

Respectfully submitted,

Reishi Naka et al.

Seed Intellectual Property Law Group PLLC

Kevin S. Costanza Registration No. 37,801

Enclosures:

Postcard Form PTO/SB/21 Copy of Filing Receipt

701 Fifth Avenue, Suite 6300 Seattle, Washington 98104-7092

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WASHINGTON, D.C. 20231

APPLICATION NUMBER | FILING DATE | GRP ART UNIT | FIL FEE REC'D | ATTY.DOCKET.NO | DRAWINGS | TOT CLAIMS | IND CLAIMS | 10/004,538 \rightarrow | 10/23/2001 \rightarrow 2859 | 870 \rightarrow 980039.409 \rightarrow 5 | 7 | 3

CONFIRMATION NO. 4403

00500 SEED INTELLECTUAL PROPERTY LAW GROUP PLLC

701 FIFTH AVE SUITE 6300

SEATTLE, WA 98104-7092

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UPDATED FILING RECEIPT

OC0000000080591831

Date Mailed: 05/08/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Reishi Naka, Asahi-shi, JAPAN; Masato Hayashi, Asahi-shi, JAPAN; Tomohiro Koyama, Asahi-shi, JAPAN; Toshikazu Hasegawa, Shinjuku-ku, JAPAN; Takeshi Aoshima, Hino-shi, JAPAN;

Assignment For Published Patent Application

Nisshinbo Industries, Inc., Chuo-ku, JAPAN; EKO Instruments Trading Co., Ltd., Shibuya-Ku, JAPAN;

Domestic Priority data as claimed by applicant

Foreign Applications

327333

JAPAN 2000 32733 10/26/2000

If Required, Foreign Filing License Granted 12/21/2001

Projected Publication Date: 08/15/2002

Non-Publication Request: No V

Early Publicati n Request: No 🗸

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MAY 1 3 2002

SEED INTELLECTUAL PROPERTY

LAW GROUP PLLC



Title

Heat conductivity measurement method and instrument and method of producing a heat winsulating material

Preliminary Class

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		mark Office: U.S. DEPARTMENT OF COMMERCE
	Application Number	ion of information unless it displays a valid OMB control number. 10/004,538
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(To be used for all correspo	Examiner Name	PEO
	Attorney Docket No	980039.409
	ENCLOSURES (check all tha	at apply)
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Amendment/Response	Drawing(s)	After Allowance
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